

Title (en)

Biscuit extrudable at negative temperatures, process for its preparation and use thereof in composite frozen confectionery products

Title (de)

Biskuitmasse welche extrudierbar ist bei negativen Temperaturen, Herstellungsverfahren der Biskuitmasse und Verwendung der Biskuitmasse in Komposit-Eiskonfekte

Title (fr)

Biscuit extrudable à température négative, procédé de préparation et utilisation dans des produits de confiserie glacée composites

Publication

EP 1356735 B1 20050119 (FR)

Application

EP 02076610 A 20020423

Priority

EP 02076610 A 20020423

Abstract (en)

[origin: EP1356735A1] The reconstituted biscuit material, which can be extruded at negative temperatures, is formed by fragments of frozen baked biscuit or a soft dough iced as a dispersion forming an expanding meringue. The dispersion also contains an expanding protein of egg white or dairy substitute and carbohydrates, frozen at a temperature of -3 degrees C to -8 degrees C. The mixture expands by 80-150%. The completed pastry has a biscuit core covered by a meringue icing.

IPC 1-7

A21D 13/08; **A23G 9/02**; **A23G 9/20**; **A23G 9/28**

IPC 8 full level

A21D 2/18 (2006.01); **A21D 2/26** (2006.01); **A21D 10/00** (2006.01); **A21D 13/00** (2006.01); **A21D 13/08** (2006.01); **A23G 9/32** (2006.01); **A23G 9/44** (2006.01); **A23G 9/48** (2006.01); **A23G 9/52** (2006.01)

CPC (source: EP US)

A21D 2/183 (2013.01 - EP US); **A21D 2/262** (2013.01 - EP US); **A21D 10/00** (2013.01 - EP US); **A21D 13/50** (2016.12 - EP US); **A23G 9/48** (2013.01 - EP US)

Cited by

EP2007216A4; FR2944949A1; WO2010125156A1; WO2007114719A1; US8475863B2

Designated contracting state (EPC)

AT BE CH CY DE DK ES FI FR GB GR IE IT LI LU MC NL PT SE TR

DOCDB simple family (publication)

EP 1356735 A1 20031029; **EP 1356735 B1 20050119**; AR 039332 A1 20050216; AT E287213 T1 20050215; AU 2003208790 A1 20031110; AU 2003208790 B2 20080501; BR 0308294 A 20041228; CA 2474899 A1 20031106; CA 2474899 C 20111115; CN 100336453 C 20070912; CN 1635836 A 20050706; DE 60202664 D1 20050224; DE 60202664 T2 20060406; ES 2234976 T3 20050701; HU P0500091 A2 20050530; IL 163147 A 20090211; JP 2005523033 A 20050804; JP 4584593 B2 20101124; MX PA04009743 A 20050111; PL 371795 A1 20050627; RU 2004133963 A 20050527; RU 2313943 C2 20080110; US 2005008748 A1 20050113; US 2009269452 A1 20091029; WO 03090544 A1 20031106; ZA 200409397 B 20060222

DOCDB simple family (application)

EP 02076610 A 20020423; AR P030101380 A 20030422; AT 02076610 T 20020423; AU 2003208790 A 20030204; BR 0308294 A 20030204; CA 2474899 A 20030204; CN 03804310 A 20030204; DE 60202664 T 20020423; EP 0301072 W 20030204; ES 02076610 T 20020423; HU P0500091 A 20030204; IL 16314704 A 20040722; JP 2003587193 A 20030204; MX PA04009743 A 20030204; PL 37179503 A 20030204; RU 2004133963 A 20030204; US 49803009 A 20090706; US 89904904 A 20040727; ZA 200409397 A 20041122